

FEATURES

Low noise 1 nV/√Hz input noise 45 nV/√Hz output noise High accuracy dc performance (AD8429BRZ) 90 dB CMRR minimum (G = 1) 50 µV maximum input offset voltage 0.02% maximum gain accuracy (G = 1) Excellent ac specifications 80 dB CMRR to 5 kHz (G = 1) 15 MHz bandwidth (G = 1) 1.2 MHz bandwidth (G = 100) 22 V/µs slew rate THD: −130 dBc (1 kHz, G = 1) Versatile ±4 V to ±18 V dual supply Gain set with a single resistor (G = 1 to 10,000) Temperature range for specified performance −40°C to +125°C

APPLICATIONS

Medical instrumentation Precision data acquisition Microphone preamplification Vibration analysis

GENERAL DESCRIPTION

The AD8429 is an ultralow noise, instrumentation amplifier designed for measuring extremely small signals over a wide temperature range (−40°C to +125°C).

The AD8429 excels at measuring tiny signals. It delivers ultralow input noise performance of 1 nV/√Hz. The high CMRR of the AD8429 prevents unwanted signals from corrupting the acquisition. The CMRR increases as the gain increases, offering high rejection when it is most needed. The high performance pin configuration of the AD8429 allows it to reliably maintain high CMRR at frequencies well beyond those of typical instrumentation amplifiers.

The AD8429 reliably amplifies fast changing signals. Its current feedback architecture provides high bandwidth at high gain, for example, 1.2 MHz at $G = 100$. The design includes circuitry to improve settling time after large input voltage transients. The AD8429 was designed for excellent distortion performance, allowing use in demanding applications such as vibration analysis.

Gain is set from 1 to 10,000 with a single resistor. A reference pin allows the user to offset the output voltage. This feature can

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1 nV/√Hz Low Noise Instrumentation Amplifier

Data Sheet **[AD8429](http://www.analog.com/AD8429?doc=AD8429.pdf)**

PIN CONNECTION DIAGRAM

be useful to shift the output level when interfacing to a single supply signal chain.

The AD8429 performance is specified over the extended industrial temperature range of −40°C to +125°C. It is available in an 8-lead plastic SOIC package.

Figure 2. RTI Voltage Noise Spectral Density vs. Frequency

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REVISION HISTORY

4/2011-Revision 0: Initial Version

SPECIFICATIONS

 $\rm V_S$ = ±15 V, $\rm V_{\rm REF}$ = 0 V, $\rm T_A$ = 25°C, G = 1, R $\rm L$ = 10 kΩ, unless otherwise noted.

Table 1.

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¹ Total voltage noise = √(e_{ni}² + (e_{no}/G)² + e_{ns}²). See th[e Theory of Operation](#page-14-0) section for more information.

 2 Total RTI $V_{OS} = (V_{OSI}) + (V_{OSO}/G)$.

 3 These specifications do not include the tolerance of the external gain setting resistor, R $_{\rm G}$. For G > 1, add R $_{\rm G}$ errors to the specifications given in this table.

ª Differential and common-mode input impedance can be calculated from the pin impedance: Z_{DIFF} = 2(Z_{PIN}); Z_{CM} = Z_{PIN}/2.
⁵ Input voltage range of the AD8429 input stage only. The input range can depend on the com See th[e Input Voltage Range](#page-15-0) section for more details.

ABSOLUTE MAXIMUM RATINGS

Table 2.

¹For voltages beyond these limits, use input protection resistors. See the [Theory of Operation](#page-14-0) section for more information.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for a device in free air using a 4-layer JEDEC printed circuit board (PCB).

Table 3.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 4. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

T = 25°C, $V_s = \pm 15$, $V_{REF} = 0$, $R_L = 10$ k Ω , unless otherwise noted.

Figure 4. Input Common-Mode Voltage vs. Output Voltage, Dual Supply, $V_S = \pm 5 V$, $\pm 12 V$, $\pm 15 V$ ($G = 1$)

Figure 5. Input Common-Mode Voltage vs. Output Voltage, Dual Supply, $V_S = \pm 5 V$, $\pm 12 V$, $\pm 15 V$ (G = 100)

Figure 6. Input Bias Current vs. Common-Mode Voltage

Figure 9. Gain vs. Frequency

Figure 12. Change in Input Offset Voltage (V_{OS}) vs. Warm-Up Time

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Figure 22. Output Voltage Swing vs. Load Resistance

Figure 27. 0.1 Hz to 10 Hz RTI Voltage Noise (G = 1, G = 1000)

Figure 29. 0.1 Hz to 10 Hz Current Noise

Figure 31. Large Signal Pulse Response and Settling Time (G = 1), 10 V Step, $V_S = \pm 15$ V

Figure 32. Large Signal Pulse Response and Settling Time (G = 10), 10 V Step, $V_S = \pm 15 V$

Figure 33. Large Signal Pulse Response and Settling Time (G = 100), 10 V Step, $V_S = \pm 15$ V

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1µs/DIV

10µs/DIV

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Figure 38. Small Signal Response (G = 1000), $R_L = 10$ k Ω , $C_L = 100$ pF

Figure 39. Small Signal Response with Various Capacitive Loads (G = 1), $R_L =$ Infinity

Figure 36. Small Signal Response (G = 10), $R_L = 10$ k Ω , $C_L = 100$ pF

1µs/DIV

09730-043

20mV/DIV

THEORY OF OPERATION

ARCHITECTURE

The AD8429 is based on the classic 3-op-amp topology. This topology has two stages: a preamplifier to provide differential amplification followed by a difference amplifier that removes the common-mode voltage and provides additional amplification[. Figure 46](#page-14-4) shows a simplified schematic of the AD8429.

The first stage works as follows. To keep its two inputs matched, Amplifier A1 must keep the collector of Q1 at a constant voltage. It does this by forcing RG− to be a precise diode drop from –IN. Similarly, A2 forces RG+ to be a constant diode drop from +IN. Therefore, a replica of the differential input voltage is placed across the gain setting resistor, RG. The current that flows through this resistance must also flow through the R1 and R2 resistors, creating a gained differential signal between the A2 and A1 outputs.

The second stage is a $G = 1$ difference amplifier, composed of Amplifier A3 and the R3 through R6 resistors. This stage removes the common-mode signal from the amplified differential signal.

The transfer function of the AD8429 is

$$
V_{OUT} = G \times (V_{IN+} - V_{IN-}) + V_{REF}
$$

where:

$$
G = 1 + \frac{6 k\Omega}{R_G}
$$

GAIN SELECTION

Placing a resistor across the R_G terminals sets the gain of the AD8429, which can be calculated by referring to [Table 5](#page-14-5) or by using the following gain equation:

$$
R_G=\frac{6\,\mathrm{k}\Omega}{G\!-\!1}
$$

Table 5. Gains Achieved Using 1% Resistors

The AD8429 defaults to $G = 1$ when no gain resistor is used. Add the tolerance and gain drift of the RG resistor to the specifications of the AD8429 to determine the total gain accuracy of the system. When the gain resistor is not used, gain error and gain drift are minimal.

RG Power Dissipation

The AD8429 duplicates the differential voltage across its inputs onto the RG resistor. Choose an R^G resistor size sufficient to handle the expected power dissipation.

REFERENCE TERMINAL

The output voltage of the AD8429 is developed with respect to the potential on the reference terminal. This is useful when the output signal must be offset to a precise midsupply level. For example, a voltage source can be tied to the REF pin to level shift the output, allowing the AD8429 to drive a single-supply ADC. The REF pin is protected with ESD diodes and should not exceed either + V_S or − V_S by more than 0.3 V.

For best performance, maintain a source impedance to the REF terminal that is well below 1 Ω. As shown i[n Figure 46,](#page-14-4) the reference terminal, REF, is at one end of a 5 kΩ resistor. Additional impedance at the REF terminal adds to this 5 k Ω resistor and results in amplification of the signal connected to the positive input. The amplification from the additional RREF can be calculated as follows:

 $2(5 \text{ k}\Omega + R_{\text{REF}})/(10 \text{ k}\Omega + R_{\text{REF}})$

Only the positive signal path is amplified; the negative path is unaffected. This uneven amplification degrades CMRR.

INPUT VOLTAGE RANGE

[Figure 4](#page-7-1) an[d Figure 5 s](#page-7-2)how the allowable common-mode input voltage ranges for various output voltages and supply voltages. The 3-op-amp architecture of the AD8429 applies gain in the first stage before removing common-mode voltage with the difference amplifier stage. Internal nodes between the first and second stages (Node 1 and Node 2 i[n Figure 46\)](#page-14-4) experience a combination of a gained signal, a common-mode signal, and a diode drop. This combined signal can be limited by the voltage supplies even when the individual input and output signals are not limited.

LAYOUT

To ensure optimum performance of the AD8429 at the PCB level, care must be taken in the design of the board layout. The pins of the AD8429 are arranged in a logical manner to aid in this task.

Common-Mode Rejection Ratio over Frequency

Poor layout can cause some of the common-mode signals to be converted to differential signals before reaching the in-amp. Such conversions occur when one input path has a frequency response that is different from the other. To maintain high CMRR over frequency, closely match the input source impedance and capacitance of each path. Place additional

source resistance in the input path (for example, for input protection) close to the in-amp inputs, which minimizes their interaction with parasitic capacitance from the PCB traces.

Parasitic capacitance at the gain setting pins can also affect CMRR over frequency. If the board design has a component at the gain setting pins (for example, a switch or jumper), choose a component such that the parasitic capacitance is as small as possible.

Power Supplies and Grounding

Use a stable dc voltage to power the instrumentation amplifier. Noise on the supply pins can adversely affect performance. See the PSRR performance curves i[n Figure 9 a](#page-7-3)n[d Figure 10 f](#page-8-0)or more information.

Place a 0.1 μF capacitor as close as possible to each supply pin. Because the length of the bypass capacitor leads is critical at high frequency, surface-mount capacitors are recommended. A parasitic inductance in the bypass ground trace works against the low impedance created by the bypass capacitor. As shown in [Figure 49,](#page-15-2) a 10 μF capacitor can be used farther away from the device. For larger value capacitors, intended to be effective at lower frequencies, the current return path distance is less critical. In most cases, this capacitor can be shared by other precision integrated circuits.

Figure 49. Supply Decoupling, REF, and Output Referred to Local Ground

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A ground plane layer is helpful to reduce parasitic inductances. This minimizes voltage drops with changes in current. The area of the current path is directly proportional to the magnitude of parasitic inductances and, therefore, the impedance of the path at high frequency. Large changes in currents in an inductive decoupling path or ground return create unwanted effects, due to the coupling of such changes into the amplifier inputs.

Because load currents flow from the supplies, the load should be connected at the same physical location as the bypass capacitor grounds.

Reference Pin

The output voltage of the AD8429 is developed with respect to the potential on the reference terminal. Ensure that REF is tied to the appropriate local ground.

INPUT BIAS CURRENT RETURN PATH

The input bias current of the AD8429 must have a return path to ground. When using a floating source without a current return path, such as a thermocouple, create a current return path, as shown i[n Figure 50.](#page-16-3)

INPUT PROTECTION

Do not allow the inputs of the AD8429 to exceed the ratings stated in th[e Absolute Maximum Ratings](#page-5-0) section of this data sheet. If this cannot be done, protection circuitry can be added in front of the AD8429 to limit the current into the inputs to a maximum current, I_{MAX}.

Input Voltages Beyond the Rails

If voltages beyond the rails are expected, use an external resistor in series with each input to limit current during overload conditions. The limiting resistor at the input can be computed from

$$
R_{\text{PROTECT}} \ge \frac{|V_{\text{IN}} - V_{\text{SUPPLY}}|}{I_{\text{MAX}}}
$$

Noise sensitive applications may require a lower protection resistance. Low leakage diode clamps, such as the BAV199, can be used at the inputs to shunt current away from the AD8429 inputs, thereby allowing smaller protection resistor values. To ensure current flows primarily through the external protection diodes, place a small value resistor, such as a 33 Ω , between the diodes and the AD8429.

Large Differential Input Voltage at High Gain

If large differential voltages at high gain are expected, use an external resistor in series with each input to limit current during overload conditions. The limiting resistor at each input can be computed by using the following equation:

$$
R_{\text{PROTECT}} \ge \frac{1}{2} \left(\frac{|V_{\text{DIFF}}| - 1 \text{V}}{I_{\text{MAX}}} - R_G \right)
$$

Noise sensitive applications may require a lower protection resistance. Low leakage diode clamps, such as the BAV199, can be used across the inputs to shunt current away from the AD8429 inputs and, therefore, allow smaller protection resistor values.

IMAX

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The maximum current into the AD8429 inputs, I_{MAX} , depends on time and temperature. At room temperature, the device can withstand a current of 10 mA for at least one day. This time is cumulative over the life of the device.

RADIO FREQUENCY INTERFERENCE (RFI)

RF rectification is often a problem when amplifiers are used in applications that have strong RF signals. The disturbance can appear as a small dc offset voltage. High frequency signals can be filtered with a low-pass RC network placed at the input of the instrumentation amplifier, as shown in [Figure 53.](#page-17-1)

The filter limits the input signal bandwidth, according to the following relationship:

$$
Filter Frequency_{DIFF} = \frac{1}{2\pi R(2C_D + C_C)}
$$

FilterFrequency_{CM} = $\frac{1}{2\pi RC_C}$

where $C_D \geq 10$ C_C .

C_D affects the difference signal, and C_C affects the common-mode signal. Choose values of R and C_c that minimize RFI. A mismatch between $R \times C_C$ at the positive input and $R \times C_C$ at the negative input degrades the CMRR of the AD8429. By using a value of C_D that is one magnitude larger than C_C , the effect of the mismatch is reduced, and performance is improved.

Resistors add noise; therefore, the choice of resistor and capacitor values depends on the desired tradeoff between noise, input impedance at high frequencies, and RFI immunity. The resistors used for the RFI filter can be the same as those used for input protection.

CALCULATING THE NOISE OF THE INPUT STAGE

Figure 54. Source Resistance from Sensor and Protection Resistors

The total noise of the amplifier front end depends on much more than the 1 nV/ \sqrt{Hz} specification of this data sheet. There are three main contributors: the source resistance, the voltage noise of the instrumentation amplifier, and the current noise of the instrumentation amplifier.

In the following calculations, noise is referred to the input (RTI). In other words, everything is calculated as if it appeared at the amplifier input. To calculate the noise referred to the amplifier output (RTO), simply multiply the RTI noise by the gain of the instrumentation amplifier.

Source Resistance Noise

Any sensor connected to the AD8429 has some output resistance. There may also be resistance placed in series with inputs for protection from either overvoltage or radio frequency interference. This combined resistance is labeled R1 and R2 i[n Figure 54.](#page-17-2) Any resistor, no matter how well made, has an intrinsic level of noise. This noise is proportional to the square root of the resistor value. At room temperature, the value is approximately equal to $4 \text{ nV}/\sqrt{\text{Hz}} \times \sqrt{\text{resistor value in k}\Omega}$.

For example, assuming that the combined sensor and protection resistance on the positive input is 4 kΩ, and on the negative input is 1 kΩ, the total noise from the input resistance is

$$
\sqrt{\left(4 \times \sqrt{4}\right)^2 + \left(4 \times \sqrt{1}\right)^2} = \sqrt{64 + 16} = 8.9 \text{ nV} / \sqrt{Hz}
$$

Voltage Noise of the Instrumentation Amplifier

The voltage noise of the instrumentation amplifier is calculated using three parameters: the device input noise, output noise, and the RG resistor noise. It is calculated as follows:

Total Voltage Noise =

$$
\sqrt{\left(OutputNoise/G\right)^{2} + \left(InputNoise\right)^{2} + \left(Noise\ of\ R_{G}Resistor\right)^{2}}
$$

For example, for a gain of 100, the gain resistor is 60.4 Ω . Therefore, the voltage noise of the in-amp is

$$
\sqrt{(45/100)^2 + 1^2 + (4 \times \sqrt{0.0604})^2} = 1.5 \text{ nV}/\sqrt{\text{Hz}}
$$

Current Noise of the Instrumentation Amplifier

Current noise is calculated by multiplying the source resistance by the current noise.

For example, if the R1 source resistance i[n Figure 54](#page-17-2) is $4 \text{ k}\Omega$, and the R2 source resistance is 1 k Ω , the total effect from the current noise is calculated as follows:

$$
\sqrt{\left(\left(4\times1.5\right)^2+\left(1\times1.5\right)^2\right)}=6.2~\text{nV}/\sqrt{\text{Hz}}
$$

Total Noise Density Calculation

To determine the total noise of the in-amp, referred to input, combine the source resistance noise, voltage noise, and current noise contribution by the sum of squares method.

For example, if the R1 source resistance i[n Figure 54](#page-17-2) is 4 k Ω , the R2 source resistance is 1 k Ω , and the gain of the in-amps is 100, the total noise, referred to input, is

$$
\sqrt{8.9^2 + 1.5^2 + 6.2^2} = 11.0 \text{ nV} / \sqrt{\text{Hz}}
$$

OUTLINE DIMENSIONS

ORDERING GUIDE

1 Z = RoHS Compliant Part.

NOTES

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